

PRODUCT SIZE



PRODUCT FEATURES

BSET soldering iron tip clean ball to remove oxides of effects of non-cleaning sponge. This new product our company developed is to reduce the lowering of temperature of tip when cleaned. this cleaner don't need water working. Can avoid splashing of residue and clear away the residual flux completely.



Usage:

1. Replace the traditional water sponge
2. Effectively prevent the oxidation of iron, iron tip to increase the service life.
3. Put the tip into the metal wire of the cleaner in order to clear away the residual solder.
4. Don't take out the metal wire to sweep the tip, since it is springy, will possibly splash the melted residual solder.
5. Please wear your gloves when exchange the metal wire. Be careful not to break the solder on. Please put the cleaner uprightly when open it.

PRODUCT PHOTOGRAPH





PRODUCT PACKAGING

WEIGHT:122.5G



PACKAGE